PARTS LIST

MAINTENANCE MANUAL 800 MHz REAR COVER ASSEMBLY 19C337097G8, G12

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DESCRIPTION

Rear Cover Assemblies 19C337097G8 and G12 consists of the 800 MHz RF Board, a die-cast aluminum case and the associated hardware. The RF Board assembly includes soldered-in modules, integrated circuits and surface-mounted components. This double-sided printed-wire board is surrounded by a die-cast aluminum casting and mounted in the rear cover case. This arrangement provides excellent RF shielding between the various circuits and the outside environment.

CIRCUIT ANALYSIS

The RF Board is electrically connected to the Control Board by two (2) single-in-line connectors. Power supplies delivered to the RF Board from the Control Board located in the Front Cover Assembly include the 7.5 Vdc (nominal) battery power supply and a regulated 5.4 Vdc supply.

Logic inputs from the Control Board include serial synthesizer loading data, a band-switch line used by the VCO, and a switched 5.4 Vdc source to enable the transmitter and disable the receiver circuits. Other inputs to the board include the RF signal when in receive

mode and both the transmit modulating audio and the transmitter power level set line when in transmit mode.

The RF Board also has several outputs. These outputs to the Control Board include the demodulated audio when the radio is receiving and a synthesizer lock status line which is active in both transmit and receive modes. During transmitter operation RF power appears at the top antenna jack or the UDC jack if an appropriate adapter is inserted.

ANTENNA SWITCH AND LOW-PASS FILTER

The antenna switch located at the top of the RF Board selects the top-mounted antenna or a UDC antenna option. A spring-loaded contact in the switch normally connects the Low-Pass Filter to the top mounted antenna. When a UDC accessory (or an RF test plug) that utilizes the UDC antenna jack is connected to the radio, the RF is routed to and from the UDC antenna jack instead of the top jack. Connecting an accessory to the UDC jack pushes the small gold plated center pin inside the unit and thus switches the filter from the top antenna jack to the UDC antenna jack.

| SYMBOL | PART NUMBER | DESCRIPTION | SYMBO | DL P |
|--------|---------------|---|----------|----------|
| R204 | 19B801251P105 | Metal film: 1 ohms ±5%, 1/10 w. | | |
| R205 | 19B801251P562 | Metal film: 5.6 ohms ±5%, 1/10 w. | | |
| R207 | 19B800607P121 | Metal film: 120 ohms ±5%, 1/8 w. | | |
| R208 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. | 2 | 19 |
| R301 | 19B801251P272 | Metal film: 2.7K ohms ±5%, 1/10 w. | 3 | 19 |
| | | ———— SWITCHES ———— | 4 | 19 |
| | | | 7 | 19 |
| SW1A | 19B235072P1 | Spring, Antenna Switch. | | |
| SW1B | 19B235071P1 | Spring, Antenna Switch. | 13 | 19 |
| SW1C | 19C337027P1 | Housing, Antenna Switch. | 10 | |
| | | — — INTEGRATED CIRCUITS — | 15 | 19 |
| U1 | RYTUA90107/1 | Module: 806-870 MHz PA, MOS FET. | 17 | 19 |
| U2 | 19A149809P1 | Module: Antenna T/R Switch; sim to MDOO3. | 18 20 | 19 19 |
| U3 | 19B800902P4 | Digital: Synthesizer, CMOS Serial Input. | 22 | 19 |
| U4 | 19B801351P17 | Module: Reference Oscillator, 13.2 MHz 1.5 PPM | | |
| U5 | 19A149810P1 | Module: Low-Pass Filter; sim to LP915A1. | | |
| U7 | 19A705706P3 | Module: 800 MHz Mixer; sim to TSM-211. | | |
| U8 | 19A705985P1 | Prescaler: /128, /129; sim to MB 501SL. | | |
| U10 | 19C851857G1 | Module: RF Amplifier. | | |
| U11 | 19C336876G1 | Module: 45.0125 MHz IF Amplifier. | | |
| U14 | 19B801642G1 | Module: Receiver Back-End. | | |
| | | ———— CRYSTALS ———— | | |
| Y2 | 19C852149G1 | Module: 800 MHz VCO. | | |
| Y3 | 19A705376P7 | Crystal, Fixed: 45.4675 MHz ±10 PPM/°C. | | |
| | | — RF BOARD MISCELLANEOUS | | |
| | | (See Drawing 188D5111) | | |
| 5 | 19A701748P1 | Tape. (Bonds C58 to U3). | | |
| 6 | 19A149008P1 | Pad. (Supports Y3). | | |
| 7 | 19A149009P1 | Pad. (Supports Y3). | | |
| 8 | 19A121175P46 | Insulator, plate. (Used near Q4, U10 and U14). | | |
| 9 | 19A705701P104 | Screw, Machine: Torx, Pan Head; M2 x 4. (Secures RF Board to Eggcrate Casting). | | |
| 10 | 19D903562P1 | Eggcrate Casting. | | |
| 11 | 19A705853P1 | Screw, Thread Forming. (Secures SW1). | | |
| 12 | 19A705701P206 | Screw, Machine: Torx, Pan Head; M2.5 x 6. (Secures PA Module and Support). | | |
| 13 | 19B234990P1 | Support, PA Module. | | |
| 18 | 19B235901P1 | Groom Clip. | | |

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| PART NUMBER | DESCRIPTION |
|--------------|--|
| | REAR COVER ASSEMBLY MISCELLANEOUS |
| | (See Drawing 19C337097) |
| 9A115983P16 | O-Ring, Rubber; .370" ID. (Used under Antenna Insert). |
| 9B801618P1 | Insert, Antenna. |
| 9B235133P1 | Connector, UDC RF. |
| 9A705701P114 | Screw, Machine: Torx, Pan Head; M2 x 14. (Secures RF Board to Rear Cover). |
| 9B801598G2 | Cover, Rear. (See separate Parts List for breakdown). |
| 9A701267P2 | Pad. |
| 9B235911P1 | Pad. (Used in G8 near C58). |
| 9B235911P2 | Pad. (Used in G8 on U4). |
| 9B235901P1 | Clip, Ground. |
| 9A121175P49 | Insulator. (Used in G8 on Y2). |

Low-Pass Filter U5 is a printed LC module which rejects unwanted harmonics. This module has a maximum passband insertion loss of 0.5 dB and a rejection of more than 30 dB in the stopband. It is a three-section elliptic network and has input and output impedances of 50 ohms.

TRANSMIT/RECEIVE SWITCH

Transmit/Receive Switch module U2 switches Low-Pass Filter U5 between the transmitter's output and the receiver's input during transmit and receive modes respectively. Pin diodes inside U2 are biased by the TX 5.4 V line to route the RF properly.

During transmitter operation, with TX 5.4 V high, RF enters the module at pin 7 and passes to the Low-Pass Filter via antenna pin 5.

In receive mode, with TX 5.4 V low, RF from the Low-Pass Filter enters the module from antenna pin 5 and is routed to the receiver's front-end via U2 pin 2.

TRANSMITTER

The 806 - 870 MHz transmitter utilizes two (2) soldered-in integrated modules to amplify VCO power: the Exciter and Power Amplifier. A third module, the Power Controller, regulates the RF output power by sampling the power output of the PA and controlling the gain of the Exciter and PA modules accordingly.

Four (4) conditions must be met to enable a transmission. The synthesizer must be loaded with proper frequency data from the Control Board, the TX 5.4 V line on J101 pin 5 must be high, and a dc voltage corresponding to the programmed RF power level must be present on the POWER SET line, J101 pin 1. The modulating signal must also be present on the TX AUDIO line, J102 pin 1.

VCO Transmitter Buffer Q6

When transmitting, the VCO's output pin 3 is in the 800 MHz range at approximately 0 dBm. This signal is applied to VCO Transmitter Buffer Q6 by a resistive attenuator network and a matching network formed by C12, C45 and R1O1. Diode D1 provides temperature compensation for Q6.

Transistor Q6 is supplied with dc power from the TX 5.4 V line during transmitter operation. This common-emitter buffer provides constant VCO output loading and amplifies the power before it is applied to the Exciter module.

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Exciter Module U9

Exciter module U9 provides approximately 23 dB of gain at full RF output power. Circuitry in this two-stage module includes an integrated circuit RF amplifier and an FET output stage. Injection is applied to pin 13 via attenuator/matching network R26 - R28. The module's output is coupled to the Power Amplifier for further amplification.

Transistor Q4 on the RF Board supplies 7.5 Vdc (±20%) battery power to the Exciter and PA modules from the 7.5 V BATT line, J102 pin 2. This pass transistor is controlled by the Power Controller module. The Power Controller increases Q4's base current (and thus its collector voltage) to increase the gain of the Exciter and PA modules. Collector voltage levels are approximately 3.5 Vdc in the low-power mode and 5.5 Vdc in the high-power mode. The dc supply is decoupled by capacitors C29, C32 and C103. C100 slows the turn-on time of the transmitter circuit.

Power Amplifier Module U1

Power Amplifier module U1 is a three-stage device physically mounted to the side "eggcrate" casting for heat dissipation. This module provides 16 dB of gain (minimum) for the transmitter when the radio is in high-power transmit mode. Injection from the Exciter at approximately 20 dBm is applied to pin 1 and the RF output appears on pin 5.

The 7.5 V BATT line supplies the PA module with 7.5 Vdc (±20%) at U1 pins 3 and 4. Capacitors C28, C30, C33 and C34 provide decoupling. Capacitors C29 and C32 decouple the power controlled source from Q4 and deliver it to U1 pin 2.

Outline and schematic diagrams for the modules are shown in the Service Section. The modules are not serviceable: schematics and outlines are given as a troubleshooting aid.

Power Controller Module A2

Power Controller module A2 regulates RF output power according to the programmed power level. The RF from the PA module enters A2 at pin 1 and exits via pin 6. Inside the module a microstrip directional-coupler samples the RF power. This signal is then rectified, filtered, and compared to the POWER SET line from the Control Board; an error signal is produced which controls the stage gains of the Exciter and PA modules.

This feedback method of power control maintains constant RF output power as set by the digital-to-analog converter circuit on the Control Board.

The POWER SET dc level at J101 pin 1 is decoupled by R45 and C3 and applied to the Power Controller at pin 12. The dc voltage levels are approximately 1.8 Vdc in the low-power mode and 2.9 Vdc in the high-power mode. Operating power for this module is supplied from the TX 5.4 V line when the radio is transmitting.

RECEIVER

The 851 - 870 MHz dual-conversion superheterodyne receiver utilizes low-side injection at the first mixer. High-IF signal is 45.0125 MHz. Second mixer high-side injection from a crystal oscillator produces the low-IF signal of 455 kHz. A front-end preselector is employed. This arrangement produces excellent sensitivity, selectivity and image rejection.

Preselector Circuit

The receiver's preselector circuit consists of two (2) non-tunable dielectric-resonator filters and RF Amplifier module U10.

Both filters are identical and have insertion losses of less than 2.2 dB in the 851 - 871 MHz passband with a minimum stopband attenuation of 35 dB. The filters have input and output impedances of 50 ohms.

When the radio is receiving, RF from the T/R Switch enters FLA1 at pin 1 and is applied to the RF Amplifier module via pin 2. RF Amplifier module U10 provides 10 dB of gain and its output is applied to the second filter via pin 4. Second filter FLA2 passes the amplified RF to the mixer. Supply power for U10 is applied to U10 pin 5 through R35. This 7.5 Vdc (nominal) source is directly from the battery supply.

VCO Receiver Buffer Q2

The VCO's output on pin 3 is applied to Receiver Buffer Q2 via a resistive attenuator network and C47. This common-emitter buffer stage provides constant VCO output loading and amplifies the signal from the VCO to supply First Mixer U7 with low-side injection. Transistor Q2 is supplied with dc power from the 7.5 V BATT line via R32. Diode D2 provides temperature compensation for the stage.

bandpass filters. In addition to the second local oscillator and mixer, this IC also contains the limiter, discriminator and the first (and only) stage of audio amplification on the RF Board. The second LO frequency is set to 45.4675 MHz by crystal Y3. L13 provides fine tuning frequency adjustment for this crystal. Inductor L14 is the quadrature detector adjustment. Demodulated audio (and data) appears on U14

pin 2 and is routed to the Control Board by J101 pin 4.

The amplified received RF signal (851 - 870 MHz) from the preselector circuit is applied pin 1 of First Mixer U7. Buffered VCO injection (806 - 825 MHz) from O2 is applied U7 pin 8. The converted signal appears on pins 3 and 4. C107 and L102 couple the converted signal to the High-IF Amplifier module. These components form a series-tuned circuit which is resonant at the intermediate frequency.

First Mixer U7, High-IF Amp U11 **Crystal Filter FLB1 And Buffer O1**

High-IF Amplifier module U11 is a single transistor common-base non-tunable transistor amplifier circuit tuned to 45.0125 MHz. The IF input is U11 pin 2. This module has input and output impedances of 50 ohms and provides 17 dB of gain. The amplified signal is then applied to FLB1.

Crystal Filter FLB1 has a 3 dB bandwidth of ±7.5 kHz at the intermediate frequency. The signal from the High-IF Amp is applied to pin 2. The LC filter network (L6, C21//C22) at the output (FLB1 pin 1) is tuned to the intermediate frequency.

The High-IF Buffer circuit, made-up of Q1 and associated components, is a common-base non-tunable amplifier stage. This stage buffers and matches the FLB1's output to the input of the back-end circuit.

Back-End Circuit

The back-end circuit performs second conversion and demodulation of the IF signal. Capacitor C17 couples the 45.0125 MHz IF signal from Q1 to U14 pin 4. Module U14 houses a 16-pin IC and two (2) series-connected 455 kHz

SYNTHESIZER

The microprocessor-controlled phased-locked loop (PLL) frequency synthesizer produces exciter drive for the transmitter and first mixer injection for the receiver. Primary components of the circuit include a stable 1.5 ppm reference oscillator, the voltage-controlled oscillator (VCO), a dualmodulus prescaler chip and a serially-loaded synthesizer chip. A PLL filter module integrates the analog error signal from the synthesizer chip before it is passed to the VCO.

Module U4 produces a 13.2 MHz crystal reference frequency for the synthesizer chip. Capacitor C8 couples this reference signal to the synthesizer chip for phase comparison to the divided VCO. During a transmission, TX AUDIO (the audio or data signal) is ac coupled to U4 pin 3 via C11 to FM the 13.2 MHz signal. Resistors R42 and R43 provide the necessary attenuation of the audio from J102 pin 1. This modulating signal is also coupled to the VCO.

Regulated and decoupled power from A1 pin 9 is applied to pin 1 by R4 and R7.

The Reference Oscillator has a small opening on the top which provides access to an internal frequency adjustment. This oscillator is highly stable and is factory adjusted. It should not normally need realignment in the field.

Voltage-Controlled Oscillator Module

The VCO module (Y2 or Y4) is the largest and most complex module on the RF Board. It generates the transmitter's drive and receiver's first LO injection. RF output on pin 3 is applied to the prescaler stage and the TX and RX buffers. The output frequency is controlled by the loop-filter tuning voltage on pin 1.

During receive operation, the VCO is locked at 45.0125 MHz less than the receive frequency.

During transmit operation, the VCO is locked to the radio's RF output frequency. The modulating signal is applied to pin 2 of the VCO. Potentiometer R5 sets the modulation level into the VCO from the TX AUDIO line.

Transistor Q5 inverts the BAND SWITCH logic level from J102 pin 3. This inverted and decoupled signal is applied to the VCO's band switch input on pin 5. BAND SWITCH (J102 pin 3) is low for radio frequencies of 806 -825 MHz and high for frequencies of 851 - 870 MHz.

Prescaler Stage Q3 And U8

VCO drive is coupled to buffer Q3 by R100 and C48. This common-emitter stage prevents the prescaler IC from loading of the VCO. Capacitor C52 couples the buffered signal to the prescaler IC and C24 decouples the supply.

Dual-modulus Prescaler U8 divides the VCO signal by 128 or 129 according to the logic level on modulus control input (MC, pin 6); the chip divides-by 128 when MC is high. Prescaler modulus is controlled by the synthesizer chip.

Synthesizer Chip U3

Integrated circuit U3 contains the reference frequency divider, variable frequency dividers and phase detectors for the synthesizer circuitry. This IC has an analog and a digital phase detector. The analog detector is incorporated in the main PLL and the digital detector's output indicates lock status to the Control Board. The reference and variable frequency dividers are serially loaded by the clocked serial lines from the I/O Microcontroller on the Control Board. U3 controls the dividing factor of the prescaler by its modulus control output on pin 8.

Serial data from the microprocessor is shifted into U3 by the DATA line, J102 pin 10. Clocking is provided on the CLOCK line, J102 pin 11, and the data is latched with the ENABLE pulse on J102 pin 9. When U3 pin 13 (LE) goes high, data is transferred from U3's internal shift registers to its dividers; low inhibits the internal transfers. The frequency tuning error signal from the analog detector appears on AN OUT, U3 pin 17.

The lock-detect output on pin 9 is sent to the Control Board via J102 pin 8. The microprocessor checks this output to prevent transmission when the VCO is not locked. During an unlocked condition, LOCK is low or pulsing.

Voltage Regulator / Loop Filter A1

Module A1 has two functions. It provides regulated 6.0 Vdc supplies to the VCO, Reference Oscillator, Synthesizer chip, Prescaler IC and back-end circuits. This module also provides active filtering of the analog error signal from the Synthesizer chip before it is applied to the VCO.

Transistor Q201 supplies a 6.0 Vdc reference voltage to A1 pin 7. This is accomplished by biasing the base to 5.4 Vdc and pulling the emitter to 6.0 Vdc using R203. This source is decoupled by C202. A linear regulator circuit in A1 samples the 6.0 Vdc source at pin 7. Using the battery power source at pin 11, this regulator supplies a well-regulated and filtered 6.0 Vdc power supply to the synthesizer and receiver circuits. A1 pin 9 supplies the synthesizer circuits with 6.0 Vdc. A1 pin 10 supplies the back-end circuits with 6.0 Vdc.

The AN OUT tuning voltage from the synthesizer chip is applied to A1 pin 6. An active filter stage in A1 integrates this error signal and the output is applied to the VCO via A1 pin 1. Pin 4 is driven by the ENABLE line. When high, the response time of the active filter circuit is decreased. This allows the synthesizer to quickly lock on frequency when new data is loaded into U3. Capacitor C58 is the primary integrating capacitor. Capacitors C55 and C57 provide further integration of the tuning error signal.

PARTS LIST

REAR COVER 19B801598G2

ISSUE 2

| SYMBOL | PART NUMBER | DESCRIF | | | |
|--------|-------------|---|--|--|--|
| | - | MISCELLAN | | | |
| 2 | 19B235075P2 | Plate, Receptacle. | | | |
| 3 | N327P9009Y6 | Rivet. | | | |
| 4 | 19D902730P1 | Gasket, Outer Seal. | | | |
| 5 | 19A705728P1 | Screw, Machine: Torx M2.6 x 14. (Secures F Cover Assemblies). | | | |
| 6 | 19A705728P2 | Screw, Machine: Torx M2.6 x 23. (Secures F Cover Assemblies). | | | |
| 7 | 19A701365P7 | Washer. (Used with al | | | |
| 9 | 19C851743P2 | Cover. | | | |
| | | | | | |
| | | | | | |

COMPONENTS, ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

PTION

NEOUS -

T6 Oval Head: Front and Rear

T6 Oval Head; Front and Rear

above Screws).

19C337097G8 EARLIER VCO 19C3

C14 and C15

C16

thru C18 C19

C20

C21

C22

C23

and C24 C25

C26

C28

C29

and C30

C32

thru C36 C41

C42

C43

19A702052P14

19A705205P2

19A700227P20

19A702236P25

19A702236P52

19A702052P14

19A705205P2

19A702052P3

19A705205P2

19A705205P6

19A702052P5

19A702052P14

19A705205P13

19A702236P52

SYMBOL PART NUMBER

19A702236P25

C44

| 19C337097G12 LATER VCO ISSUE 3 | | | |
|-----------------------------------|---------------|---|--|
| SYMBOL | PART NUMBER | DESCRIPTION | |
| | | RF BOARD 19D902395G1(Used in G8) RF BOARD 19D902395G3 (Used in G8) RF BOARD 19D902395G5 (Used in G12) | |
| | | ————— MODULES———— | |
| A1 * | 19C852056G1 | PLL Low-Pass Filter/Regulator Module. | |
| A2 | 19C851922G1 | Power Controller Module. | |
| | | ———— CAPACITORS ——— | |
| C2 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. | |
| C3 and C4 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. | |
| C6 | 19A702052P1 | Ceramic: 220 pF ±10%, 50 VDCW. | |
| C7 | 19A702052P8 | Ceramic: 3300 pF $\pm 10\%$, 50 VDCW. | |
| C8 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. | |
| C10 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. | |
| C11 | 19A705205P6 | Tantalum: $10 \mu\text{F}$, 16VDCW ; sim to Sprague 293D. (Used in G1). | |
| C11 | 19A705205P222 | Tantalum: 1 $\mu F,$ 50 VDCW. (Used in G3 and G5). | |
| C12 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. | |
| C13 | 19A702052P5 | Ceramic: 1000 pF \pm 10%, 50 VDCW. | |
| C14 and | | 19A702236P30Ceramic: 15 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/°C. | |

Ceramic: 0.01 μF ±10%, 50 VDCW.

Tantalum: 1 µF, 16 VDCW; sim to

Ceramic: 5.6 pF \pm 5%, 100 VDCW. Ceramic: 10 pF \pm .5 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C.

Ceramic: 120 pF, ±5%, 50 VDCW.

Ceramic: 0.01 μF ±10%, 50 VDCW.

Tantalum: 1 µF, 16 VDCW; sim to

Ceramic: 470 pF ±10%, 50 VDCW.

Tantalum: 1 µF, 16 VDCW; sim to

Tantalum: 10 μ F, 16 VDCW; sim to

Ceramic: 1000 pF $\pm 10\%$, 50 VDCW.

Ceramic: 0.01 μF ±10%, 50 VDCW.

Tantalum: 4.7 µF, 10 VDCW; sim to

Ceramic: 120 pF, ±5%, 50 VDCW.

Sprague 293D.

Sprague 293D.

Sprague 293D.

Sprague 293D.

Sprague 293D.

| C44 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0±+30 PPM/°C. | | | |
|---------------------|--------------|---|-----------------|----------------|---|
| C45 | 19A702236P11 | Ceramic: 2.7 pF \pm 0.25 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | D1 and D2 | 19A700155P2 | Silicon: 100 mA, 35 PIV; sim to BAT 18. |
| C47 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. | D201 | 19A700155P2 | Silicon: 100 mA, 35 PIV; sim to BAT 18. |
| C48 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. | D202 | 19A702525P2 | Silicon, PIN: sim to MMBV3401. |
| C49 | 19A705205P2 | Tantalum: 1 uF, 16 VDCW; sim to Sprague 293D. | FLA1 | 19A704888P1 | Bandpass Filter, 851-871 MHz; sim |
| C50 and C51 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. | and FLA2 | 19A705328P5 | to: Murata DFC3R861P020BTD. |
| C52 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. | FLB1 | 19A705328P5 | Monolithic Crystal: 45.0125 MHz; sim to Toyocom 45E2BU. |
| C53 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. | | | JACKS |
| and C54 | | | J101 | 19A149614P1 | Connector: 5 sockets; sim to DuPont 69755-005. |
| C55 | 19A702052P3 | Ceramic: 470 pF \pm 10%, 50 VDCW. | J102 | 19A149614P2 | Connector: 11 sockets; sim to DuPont 69755-011. |
| C56 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | | | ———— INDUCTORS ——— |
| C57 | 19A703902P3 | Metal: 0.047 uF ±10%, 50 VDCW. | L5 | 19A705470P1 | Coil, fixed: 10 nH; sim to Toko |
| C58 | 19A703902P4 | Metal: 0.56 uF ±10%, 50 VDCW. | | | 380NB-10nM. |
| C59 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. | L6 | 19A705470P14 | Coil, fixed: 0.12 µH; sim to Toko 380NB-R12M. |
| C60 | 19A702236P25 | Ceramic: 10 pF \pm .5 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | L12 | 19A705470P1 | Coil, fixed: 10 nH; sim to Toko 380NB-10nM. |
| C100 | 19A705205P2 | Tantalum: 1 μF, 16 VDCW; sim to Sprague 293D. | L13 | 19A703591P2 | IF: sim to Toko America 332PN-T10162 |
| C101 | 19A702236P15 | Ceramic: 3.9 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. | L14 | 19A703591P1 | IF: sim to Toko America P5SVLC-A291EL. |
| C103 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | L100 and | 19A705470P | 1Coil, fixed: 10 nH; sim to Toko 380NB-10nM. |
| C104 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. | L101 L102 | 19A705470P21 | Coil, fixed: 0.47 µH; sim to Toko |
| C104 * | 19A702236P23 | Ceramic: 8.2 pF, \pm 0.5%, 50 VDCW temp coef 0 \pm 60 PPM/°C. (Used in G5). | L102 | 19A705470P21 | 380NB-R47M. Coil, fixed: 0.22 μ H; sim to Toko |
| C105 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | L201 | 19A705470P17 | Soll, fixed: 0.22 µH, sim to Toko 380NB-R22M. Coil, fixed: 10 nH; sim to Toko |
| C106 | 19A702236P42 | Ceramic: 47 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | L301 * | 344A4540P100 | 380NB-10nM. Inductor, chip: 10 nH ±5%. |
| C107 | 19A702236P36 | Ceramic: 27 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | 2001 | 344743401 100 | ———— TRANSISTORS ——— |
| C108 | 19A702236P44 | Ceramic: 56 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | Q1 | 19A703654P2 | Silicon, NPN: sim to Motorola MMBR901. |
| C109 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | Q2 and | 19A704708P2 | Silicon, NPN: sim to NEC 2SC3356. |
| C201 | 19A702236P15 | Ceramic: 3.9 pF ±.25 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. | Q3 Q4 | 19A149542P1 | Silicon, PNP: sim to Motorola |
| C202 | 19A705205P13 | Tantalum: 4.7 $\mu F,$ 10 VDCW; sim to Sprague 293D. | Q5 | 19A700076P2 | MJD32C-1. Silicon, NPN: sim to MMBT3904, low profile. |
| C203 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. | Q6 | 19A704708P2 | Silicon, NPN: sim to NEC 2SC3356. |
| C204 and C205 | 19A702236P42 | Ceramic: 47 pF \pm 5%, 50 VDCW, temp coef 0 +30 PPM/° C. | Q201 | 19A700059P2 | Silicon, PNP: sim to MMBT3906, low profile. |
| C207 thru | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 +30 PPM/°C. | | | RESISTORS |
| C209 | | | R | 119B801251P104 | Metal film: 100K ohms \pm 5%, 1/10 w. |
| C210 | 19A702236P19 | Ceramic: 5.6 pF \pm .5 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | R2 | 19B801251P222 | Metal film: 2.2K ohms ±5%, 1/10 w. |
| C211 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. | R3 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. |
| C212 | 19A705205P2 | Tantalum: 1 μ F, 16 VDCW; sim to | R4 | 19B801251P100 | Metal film:10 ohms ±5%, 1/10 w. |
| 5212 | | Sprague 293D. | R5 | 19B800779P10 | Variable: 10K ohms ±25%, 100 VDCW, .3 watt. |

* COMPONENTS, ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

PARTS LIST

DESCRIPTION

Ceramic: 10 pF ±.5 pF, 50 VDCW,

SYMBOL PART NUMBER

SY

DESCRIPTION

---- DIODES -----

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| | r | |
|--------------------|---------------|---|
| SYMBOL | PART NUMBER | DESCRIPTION |
| R6 | 19B801251P273 | Metal film: 27K ohms \pm 5%, 1/10 w. |
| R7 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R8 | 19B801251P510 | Metal film: 51 ohms ±5%, 1/10 w. |
| R10 | 19B801251P821 | Metal film: 820 ohms $\pm 5\%$, 1/10 w. |
| R11 | 19B801251P100 | Metal film: 10 ohms \pm 5%, 1/10 w. |
| and R12 | | |
| R13 | 19B801251P183 | Metal film: 18K ohms \pm 5%, 1/10 w. |
| R14 | 19B801251P103 | Metal film: 10K ohms $\pm 5\%$, 1/10 w. |
| R15 | 19B801251P223 | Metal film: 22K ohms \pm 5%, 1/10 w. |
| R16 | 19B801251P391 | Metal film: 390 ohms ±5%, 1/10 w. |
| R17 | 19B801251P182 | Metal film: 1.8K ohms ±5%, 1/10 w. |
| R18 | 19B801251P222 | Metal film: 2.2K ohms ±5%, 1/10 w. |
| R19 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| and R20 | | |
| R21 | 19B801251P152 | Metal film: 1.5K ohms ±5%, 1/10 w. |
| R22 | 19B801251P331 | Metal film: 330 ohms ±5%, 1/10 w. |
| R23 | 19B801251P103 | Metal film: 10K ohms \pm 5%, 1/10 w. |
| and R24 | | |
| R25 | 19B801251P222 | Metal film: 2.2K ohms \pm 5%, 1/10 w. |
| R26 | 19B801251P271 | Metal film: 270 ohms $\pm 5\%$, 1/10 w. |
| and R27 | | |
| R28 | 19B801251P180 | Metal film: 18 ohms ±5%, 1/10 w. |
| R29 | 19B800607P1 | Metal film: Jumper. |
| R30 | 19B801251P103 | Metal film: 10K ohms \pm 5%, 1/10 w. |
| R31 | 19B801251P562 | Metal film: 5.6K ohms \pm 5%, 1/10 w. |
| R33 | 19B801251P750 | Metal film: 75 ohms \pm 5%, 1/10 w. |
| R34 and R35 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R36 thru R38 | 19B801251P102 | Metal film: 1K ohms \pm 5%, 1/10 w. |
| R39 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R40 | 19B801251P390 | Metal film: 39 ohms ±5%, 1/10 w. |
| R41 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R42 | 19B801251P333 | Metal film: 33K ohms \pm 5%, 1/10 w. |
| R43 | 19B801251P472 | Metal film: 4.7K ohms ±5%, 1/10 w. (Used in G1). |
| R43 | 19B801251P562 | Metal film: 5.6K ohms±5%, 1/10 w. (Used in G3 and G5). |
| R44 | 19B801251P223 | Metal film: 22K ohms \pm 5%, 1/10 w. |
| R45 | 19B801251P102 | Metal film: 1K ohms \pm 5%, 1/10 w. |
| R46 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R47 | 19B801251P333 | Metal film: 33K ohms \pm 5%, 1/10 w. |
| R48 | 19B801251P682 | Metal film: 6.8K ohms \pm 5%, 1/10 w. |
| R50 | 19B801251P390 | Metal film: 39 ohms \pm 5%, 1/10 w. |
| R52 | 19B801251P152 | Metal film: 1.5K ohms ±5%, 1/10 w. |
| R53 | 19B801251P750 | Metal film: 75 ohms \pm 5%, 1/10 w. |
| R100 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. |
| R101 | 19B800607P1 | Metal film: Jumper. |
| R102 | 19B801251P472 | Metal film: 4.7K ohms \pm 5%, 1/10 w. |
| | | |

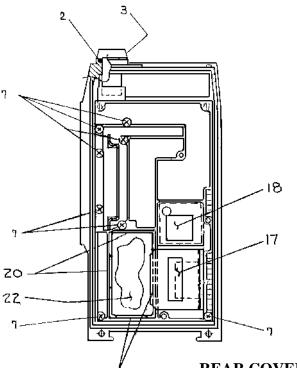
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PARTS LIST

| SYMPOL | PART NUMBER | DESCRIPTION | |
|--------|---------------|--|--|
| SYMBOL | PARTNUMBER | DESCRIPTION | |
| R105 | 19B800607P1 | Metal film: Jumper. | |
| R201 | 19B801251P104 | Metal film: 100K ohms ±5%, 1/10 w. | |
| R202 | 19B801251P153 | Metal film: 15K ohms \pm 5%, 1/10 w. | |
| R203 | 19B801251P472 | Metal film: 4.7K ohms \pm 5%, 1/10 w. | |
| R204 | 19B801251P181 | Metal film: 180 ohms±5%, 1/10 w. (Used in G1). | |
| R204 | 19B801251P271 | Metal film: 270 ohms \pm 5%, 1/10 w. (Used in G3 and G5). | |
| R205 | 19B801251P181 | Metal film: 180 ohms \pm 5%, 1/10 w. (Used in G1). | |
| R205 | 19B801251P271 | Metal film: 270 ohms \pm 5%, 1/10 w. (Used in G3 and G5). | |
| R206 | 19B801251P330 | Metal film: 33 ohms \pm 5%, 1/10 w. (Used in G1). | |
| R206 | 19B801251P180 | Metal film: 18 ohms ±5%, 1/10 w. (Used in G3 and G5). | |
| R207 | 19B800607P121 | Metal film: 120 ohms ±5%, 1/8 w. | |
| R208 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. | |
| R209 * | 3R151P470J | Composition: 47 ohms \pm 5%, 1/8 w. | |
| | | SWITCHES | |
| SW1A | 19B235072P1 | Spring, Antenna Switch. | |
| SW1B | 19B235071P1 | Spring, Antenna Switch. | |
| SW1C | 19C337027P1 | Housing, Antenna Switch. | |
| | | —— INTEGRATED CIRCUITS — | |
| U1 | 19A705962P1 | Module: 806-870 MHz PA; sim to M67706. | |
| U2 | 19A149809P1 | Module: Antenna T/R Switch; sim to MDOO3. | |
| U3 | 19B800902P4 | Digital: Synthesizer, CMOS Serial Input. | |
| U4 * | 19B235948G2 | Module: Reference Oscillator, 13.2 MHz 1.5 PPM. (Used in G1). | |
| U4 | 19B235948G1 | Module: Reference Oscillator, 13.2 MHz ±1.5 PPM. (Used in G3 and G5). | |
| U5 | 19A149810P1 | Module: Low-Pass Filter; sim to LP915A1. | |
| U7 | 19A705706P3 | Module: 800 MHz Mixer; sim to TSM-211. | |
| U8 | 19A705985P1 | Prescaler: /128, /129; sim to MB 501SL. | |
| U9 | 19C851848G1 | Module: 806-870 MHz Exciter. | |
| U10 | 19C851857G1 | Module: RF Amplifier. | |
| U11 | 19C336876G1 | Module: 45.0125 MHz IF Amplifier. | |
| U14 | 19B801642G1 | Module: Receiver Back-End. | |
| | | ———— CRYSTALS———— | |
| Y2 * | 19B235947G1 | Module: 800 MHz VCO. (Used in G1 and G3). | |
| Y3 | 19A705376P7 | Crystal, Fixed: 45.4675 MHz±10 PPM/°C. | |
| Y4 | 19C852149G1 | Module: 800 MHz VCO. (Used in G5). | |
| | | — RF BOARD MISCELLANEOUS | |
| | | (See Drawing 19D902395) | |
| 5 | 19A701748P1 | Tape. (Bonds C58 to U3). | |
| 6 | 19A149008P1 | Pad. (Supports Y3). | |
| 7 | 19A149009P1 | Pad. (Supports Y3). | |
| | | | |

| SYMBOL | PART NUMBER | DESCRIPTION |
|--------|---------------|---|
| 8 | 19A121175P46 | Insulator, plate. (Used near Q4, U10 and U14). |
| 9 | 19A705701P104 | Screw, Machine: Torx, Pan Head; M2 x 4. (Secures RF Board to Eggcrate Casting |
| 10 | 19D903562P1 | Eggcrate Casting. (Used in G1 and G3). |
| 11 | 19A705853P1 | Screw, Thread Forming. (Secures SW1) |
| 12 | 19A705701P206 | Screw, Machine: Torx, Pan Head; M2.5 x 6. (Secures PA Module and Support). |
| 13 | 19B234990P1 | Support, PA Module. |
| 16 | 19D903562P1 | Eggcrate Casting. (Used in G5). |
| | | REAR COVER ASSEMBLY MISCELLANEOUS |
| | | (See Drawing 19C337097) |
| 2 | 19A115983P16 | O-Ring, Rubber; .370" ID. (Used under Antenna Insert). |
| 3 | 19B801618P1 | Insert, Antenna. |
| 4 | 19B235133P1 | Connector, UDC RF. |
| 7 | 19A705701P114 | Screw, Machine: Torx, Pan Head; M2 x 14. (Secures RF Board to Rear Cover). |
| 13 | 19B801598G2 | Cover, Rear. (See separate Parts List for breakdown). |
| 15 | 19A701267P2 | Pad. |
| 17 | 19B235911P1 | Pad. (Used in G8 near C58). |
| 18 | 19B235911P2 | Pad. (Used in G8 on U4). |
| 20 | 19B235901P1 | Clip, Ground. |
| 22 | 19A121175P49 | Insulator. (Used in G8 on Y2). |

13 nnnnn



20

Production Changes

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter" which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for the descriptions of parts affected by these revisions.

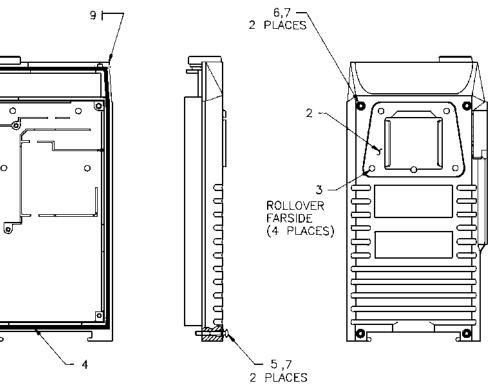


REV. C - <u>REAR COVER ASSEMBLY 19C337097G8</u> <u>RF BOARD 19D902395G1</u> RF Board 19D902395G3 replaces RF Board 19D902395G1. REV. D - <u>REAR COVER ASSEMBLY 19C337097G8</u> <u>RF BOARD 19D902395G1</u>

No change.

REV. A - <u>REAR COVER ASSEMBLY 19C337097G12</u> <u>RF BOARD 19D902395G5</u>

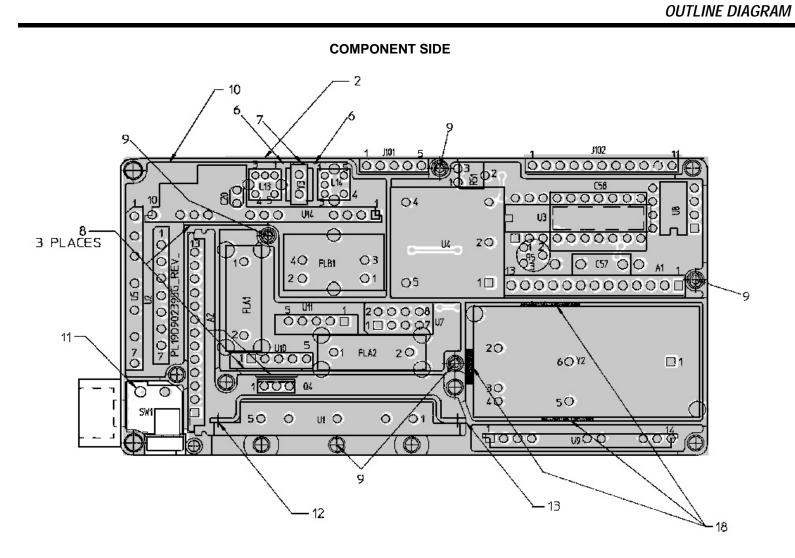
To increase RF Power Out performance thereby improving Test Yield. The following changes were made: C104 from 19D702236P52 (120pF) to 19D702236P23 (8.2pF). Added: L301 344A4540P100.

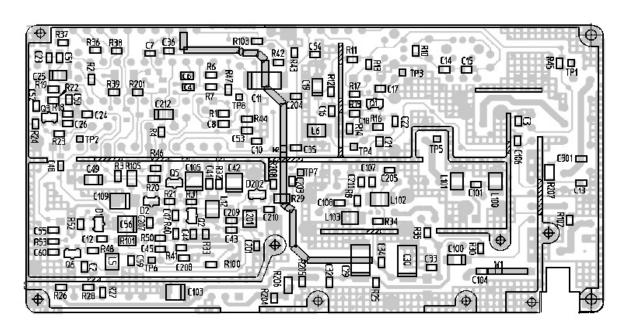


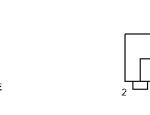
MECHANICAL PARTS

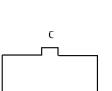
REAR COVER ASSEMBLY 19C337097G8, G12 (19C337097, Sh. 2, Rev. 0)

REAR COVER 19B801598G2 (19B801598, Sh. 1, Rev. 3)











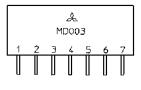
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SOLDER SIDE

PIN ASSIGNMENTS

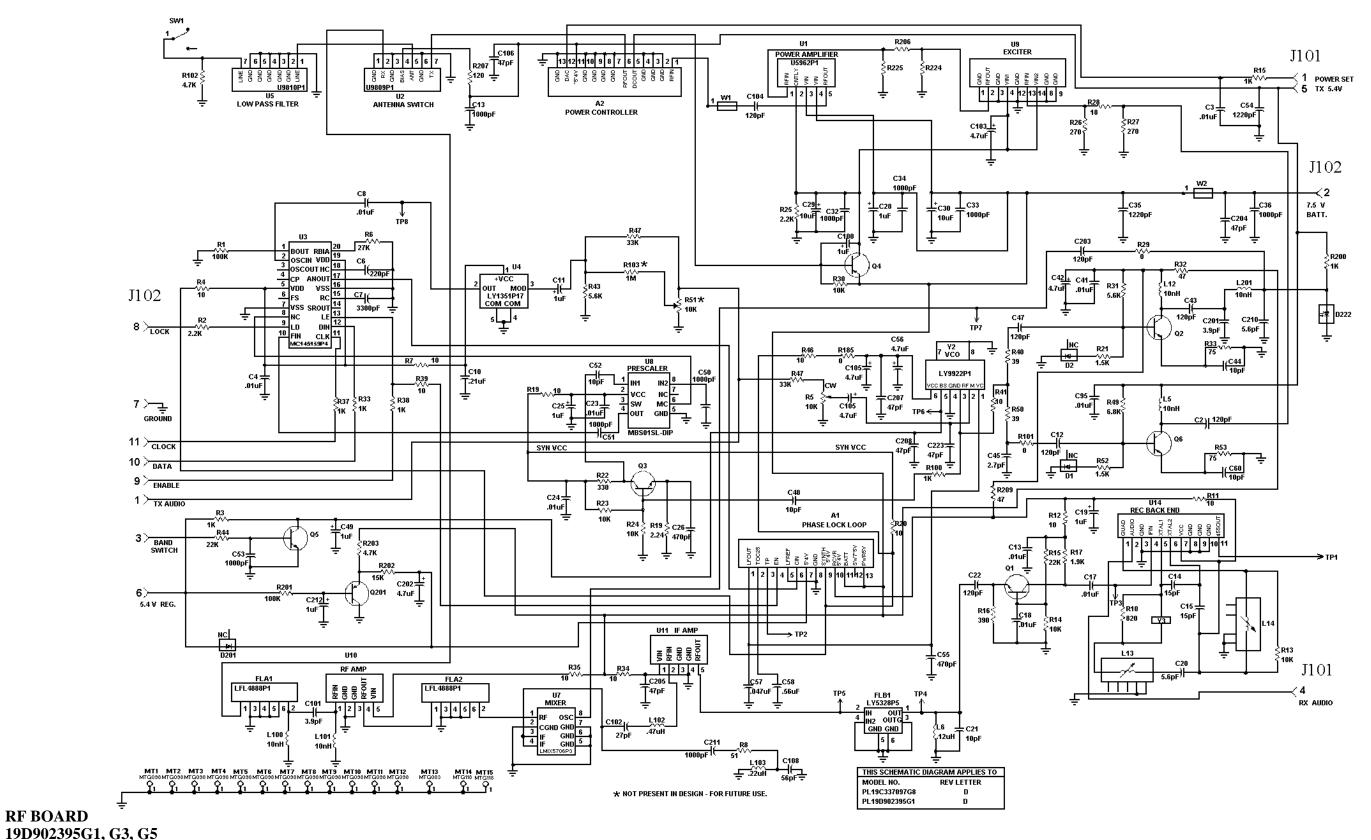




PIN ASSIGNMENT FOR U2

RF BOARD 19D902395G1, G3, G5

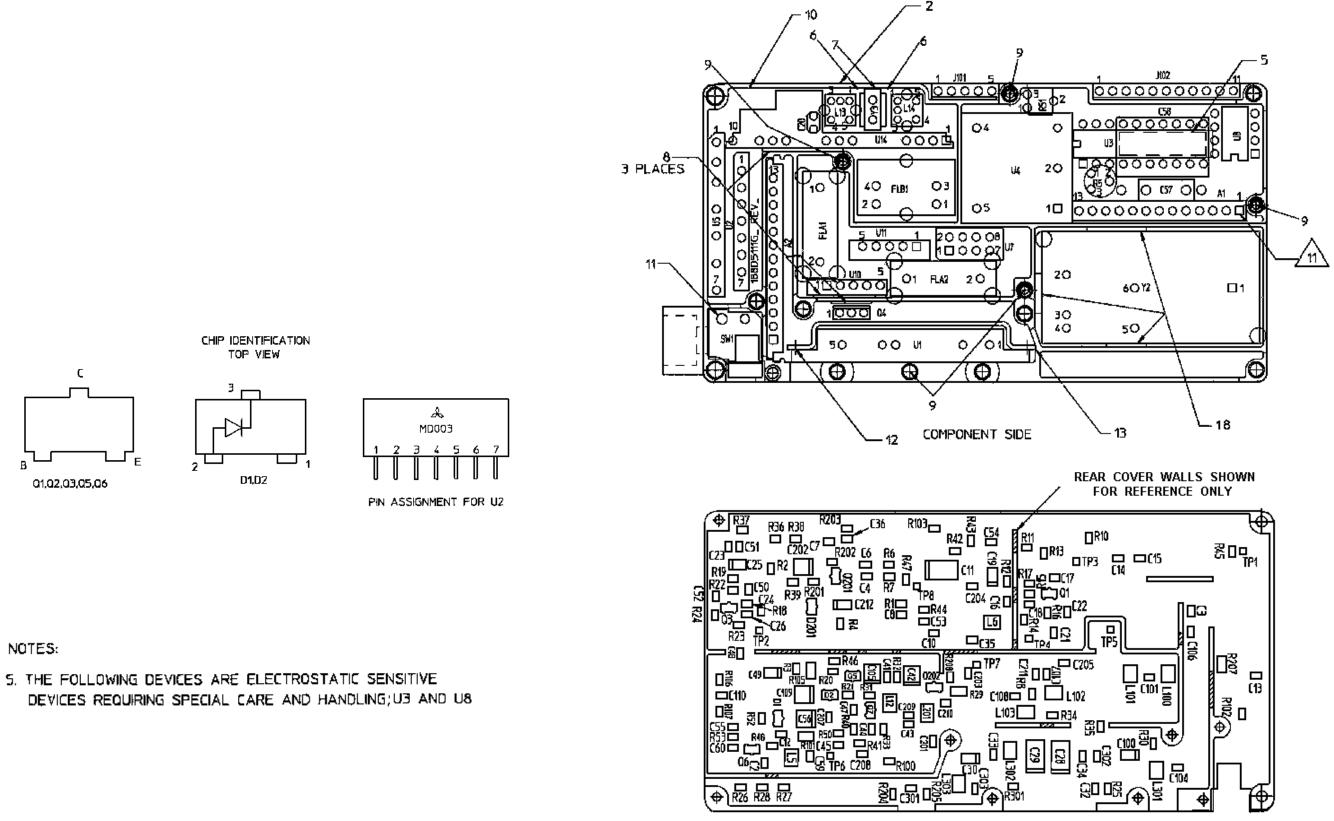
(19D902395, Sh. 1, Rev. 0) (19D902396, Component Side, Rev. 0) (19D902396, Solder Side, Rev. 0)



(19D902397, Sh. 1, Rev. 3)

RF BOARD

OUTLINE DIAGRAM



С

01,02,03,05,06

NOTES:

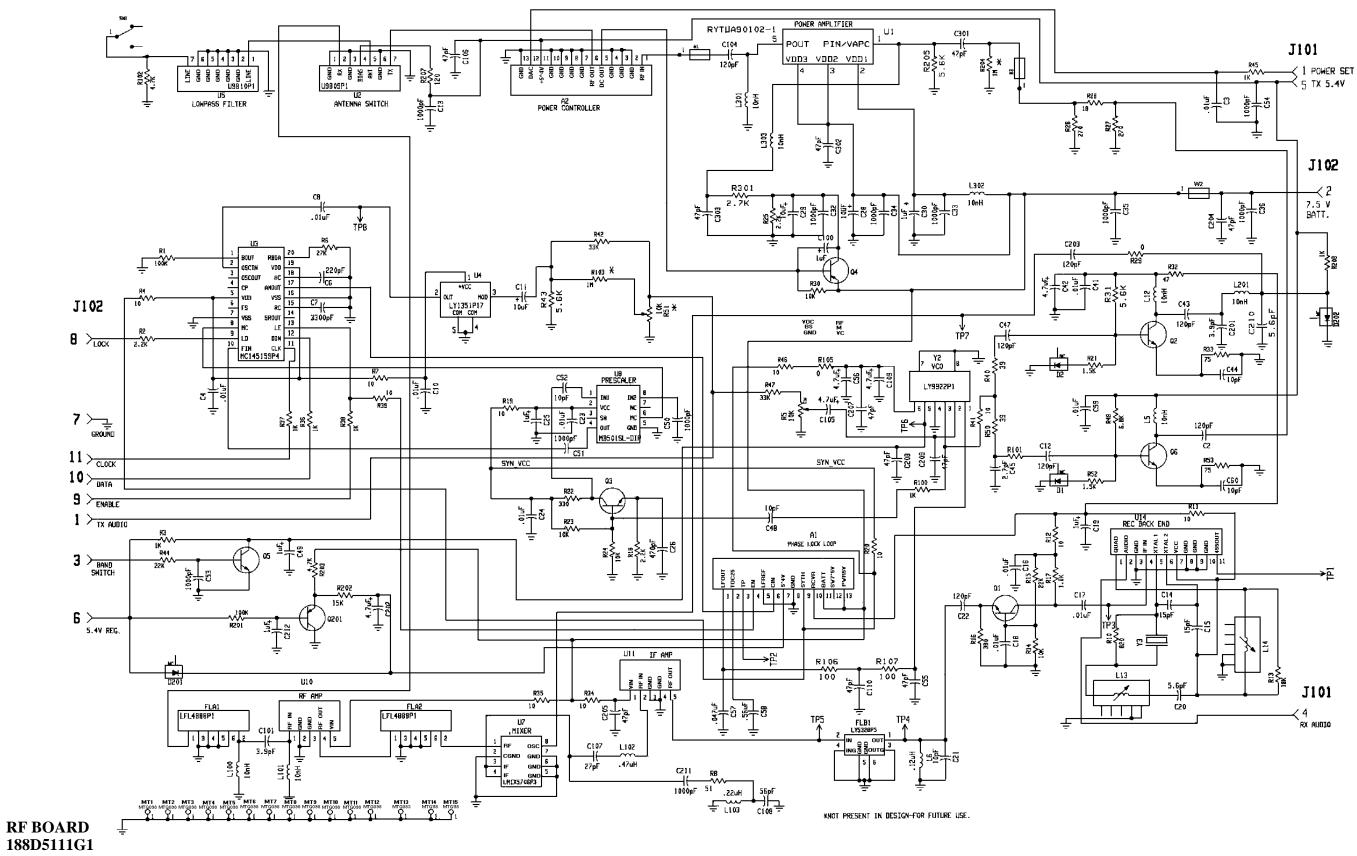
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VIEWED FROM SOLDER SIDE

LBI-38466



(188D5111, Rev. 0)



(188D5109, Rev. 0)

800 MHz REAR COVER ASSEMBLY 19C337097G12 LATER VCO

ISSUE 1

| SYMBOL | PART NUMBER | DESCRIPTION |
|--------------------|---------------|---|
| | | 188D5111G1 |
| | | — — — — — MODULES — — — — |
| A1 | 19C852056G1 | PLL Low-Pass Filter/Regulator Module. |
| A2 | 19C851922G1 | Power Controller Module. |
| | | ———— CAPACITORS ——— |
| C2 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. |
| C3 and C4 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. |
| C6 | 19A702052P1 | Ceramic: 220 pF \pm 10%, 50 VDCW. |
| C7 | 19A702052P8 | Ceramic: 3300 pF $\pm 10\%$, 50 VDCW. |
| C8 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. |
| C10 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. |
| C11 | 19A705205P222 | Tantalum: 1 µF, 50 VDCW. |
| C12 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. |
| C13 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. |
| C14 and C15 | 19A702236P30 | Ceramic: 15 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/°C. |
| C16 thru C18 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. |
| C19 | 19A705205P2 | Tantalum: 1 μF, 16 VDCW; sim to Sprague 293D. |
| C20 | 19A700227P20 | Ceramic: 5.6 pF \pm 5%, 100 VDCW. |
| C21 | 19A702236P25 | Ceramic: 10 pF \pm .5 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C. |
| C22 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. |
| C23 and C24 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. |
| C25 | 19A705205P2 | Tantalum: 1 μF, 16 VDCW; sim to Sprague 293D. |
| C26 | 19A702052P3 | Ceramic: 470 pF ±10%, 50 VDCW. |
| C28 and C29 | 19A705205P6 | Tantalum: 10 μF, 16 VDCW; sim to Sprague 293D. |
| C30 | 19A705205P2 | Tantalum: 1 μF, 16 VDCW; sim to Sprague 293D. |
| C32 thru C36 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. |
| C41 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. |
| C42 | 19A705205P13 | Tantalum: 4.7 µF, 10 VDCW; sim to Sprague 293D. |
| C43 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. |
| C44 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0±+30 PPM/°C. |
| C45 | 19A702236P11 | Ceramic: 2.7 pF ±0.25 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. |
| C47 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. |
| C48 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, |
| * COMPO | • | ED OR CHANGED BY PRODUCTION CHANGES |

| SYMBOL | PART NUMBER | DESCRIPTION | SYMBOL | PART NUMBER | DESCRIPTION |
|---------------------|------------------|---|---------------------|----------------|---|
| C49 | 19A705205P2 | Tantalum: 1 uF, 16 VDCW; sim to | | | ———— FILTERS ———— |
| C50 and | 19A702052P5 | Sprague 293D. Ceramic: 1000 pF ±10%, 50 VDCW. | FLA1 and FLA2 | 19A704888P1 | Bandpass Filter, 851-870 MHz; sim to: Murata DFC3R861P020BTD. |
| C51 C52 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. | FLB1 | 19A705328P5 | Monolithic Crystal: 45.0125 MHz; sim to Toyocom 45E2BU. |
| C53 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. | | | ———— JACKS ———— |
| and C54 | | | J101 | 19A149614P1 | Connector: 5 sockets; sim to DuPont 69755-005. |
| C55 | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/°C | J102 | 19A149614P2 | Connector: 11 sockets; sim to DuPont 69755-011. |
| C56 | 19A705205P13 | Tantalum: 4.7 μ F, 10 VDCW; sim to Sprague 293D. | | | INDUCTORS |
| C57 | 19A703902P3 | Metal: 0.047 uF ±10%, 50 VDCW. | L5 | 19A705470P1 | Coil, fixed: 10 nH; sim to Toko |
| C58 | 19A703902P4 | Metal: 0.56 uF ±10%, 50 VDCW. | | | 380NB-10nM. |
| C59 | 19A702052P14 | Ceramic: 0.01 μF ±10%, 50 VDCW. | L6 | 19A705470P14 | Coil, fixed: 0.12 µH; sim to Toko 380NB-R12M. |
| C60 | 19A702236P25 | Ceramic: 10 pF ±.5 pF, 50 VDCW, temp coef 0 ±30 PPM/°C. | L12 | 19A705470P1 | Coil, fixed: 10 nH; sim to Toko 380NB-10nM. |
| C100 | 19A705205P2 | Tantalum: 1 μF, 16 VDCW; sim to | L13 | 19A703591P2 | IF: sim to Toko America 332PN-T1016Z |
| C101 | 19A702236P15 | Sprague 293D. Ceramic: 3.9 pF ±.25 pF, 50 VDCW, | L14 | 19A703591P1 | IF: sim to Toko America P5SVLC-A291EL. |
| C104 | 19A702236P23 | temp coef 0 ±30 PPM/°C. Ceramic: 8.2 pF, ±0.5pF, 50 VDCW, temp coef 0 ±60 PPM/°C. | L100 and L101 | 19A705470P | 1Coil, fixed: 10 nH; sim to Toko 380NB-10nM. |
| C105 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | L102 | 19A705470P21 | Coil, fixed: 0.47 μH; sim to Toko 380NB-R47M. |
| C106 | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/°C. | L103 | 19A705470P17 | Coil, fixed: 0.22 μH; sim to Toko 380NB-R22M. |
| C107 | 19A702236P36 | Ceramic: 27 pF ±5%, 50 VDCW, temp coef 0 ±30 PPM/°C. | L201 and L301 | 19A705470P1 | Coil, fixed: 10 nH; sim to Toko 380NB-10nM. |
| C108 | 19A702236P44 | Ceramic: 56 pF \pm 5%, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | L302 and | 19A705470P6 | Coil, fixed: 27 nH; sim to Toko 380NB-27nM. |
| C109 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | L303 | | |
| C110 | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 +30 PPM/°C. | Q1 | 19A703654P2 | — — — — TRANSISTORS — — — — Silicon, NPN: sim to Motorola |
| C201 | 19A702236P15 | Ceramic: 3.9 pF \pm .25 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | Q2 | 19A704708P2 | MMBR901. Silicon, NPN: sim to NEC 2SC3356. |
| C202 | 19A705205P13 | Tantalum: 4.7 μF, 10 VDCW; sim to Sprague 293D. | and Q3 | | |
| C203 | 19A702236P52 | Ceramic: 120 pF, ±5%, 50 VDCW. | Q4 | 19A149542P1 | Silicon, PNP: sim to Motorola MJD32C-1. |
| C204 and C205 | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 +30 PPM/°C. | Q5 | 19A700076P2 | Silicon, NPN: sim to MMBT3904, low profile. |
| C205 | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, | Q6 | 19A704708P2 | Silicon, NPN: sim to NEC 2SC3356. |
| thru C209 | 13/11/02/2001 42 | temp coef 0 +30 PPM/°C. | Q201 | 19A700059P2 | Silicon, PNP: sim to MMBT3906, low profile. |
| C210 | 19A702236P19 | Ceramic: 5.6 pF \pm .5 pF, 50 VDCW, temp coef 0 \pm 30 PPM/°C. | | | RESISTORS |
| C211 | 19A702052P5 | Ceramic: 1000 pF ±10%, 50 VDCW. | R | 119B801251P104 | Metal film: 100K ohms \pm 5%, 1/10 w. |
| C212 | 19A705205P2 | Tantalum: 1 μF, 16 VDCW; sim to | R2 | 19B801251P222 | Metal film: 2.2K ohms \pm 5%, 1/10 w. |
| 0004 | 40.47000000040 | Sprague 293D. | R3 | 19B801251P102 | Metal film: 1K ohms \pm 5%, 1/10 w. |
| C301 thru | 19A702236P42 | Ceramic: 47 pF ±5%, 50 VDCW, temp coef 0 +30 PPM/°C. | R4 | 19B801251P100 | Metal film:10 ohms ±5%, 1/10 w. |
| C303 | | | R5 | 19B800779P10 | Variable: 10K ohms $\pm 25\%$, 100 VDCW, .3 watt. |
| | | | R6 | 19B801251P273 | Metal film: 27K ohms \pm 5%, 1/10 w. |
| D1 and | 19A700155P2 | Silicon: 100 mA, 35 PIV; sim to BAT 18. | R7 | 19B801251P100 | Metal film: 10 ohms \pm 5%, 1/10 w. |
| D2 | | | R8 | 19B801251P510 | Metal film: 51 ohms ±5%, 1/10 w. |
| | | | R10 | 19B801251P821 | Metal film: 820 ohms \pm 5%, 1/10 w. |

PARTS LIST

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LBI-38466

| SYMBOL | PART NUMBER | DESCRIPTION |
|---------------------|---------------|---|
| R11 and R12 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R13 | 19B801251P183 | Metal film: 18K ohms \pm 5%, 1/10 w. |
| R14 | 19B801251P103 | Metal film: 10K ohms \pm 5%, 1/10 w. |
| R15 | 19B801251P223 | Metal film: 22K ohms \pm 5%, 1/10 w. |
| R16 | 19B801251P391 | Metal film: 390 ohms \pm 5%, 1/10 w. |
| R17 | 19B801251P182 | Metal film: 1.8K ohms \pm 5%, 1/10 w. |
| R18 | 19B801251P222 | Metal film: 2.2K ohms \pm 5%, 1/10 w. |
| R19 and R20 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R21 | 19B801251P152 | Metal film: 1.5K ohms \pm 5%, 1/10 w. |
| R22 | 19B801251P331 | Metal film: 330 ohms \pm 5%, 1/10 w. |
| R23 and R24 | 19B801251P103 | Metal film: 10K ohms \pm 5%, 1/10 w. |
| R25 | 19B801251P222 | Metal film: 2.2K ohms \pm 5%, 1/10 w. |
| R26 and R27 | 19B801251P271 | Metal film: 270 ohms ±5%, 1/10 w. |
| R28 | 19B801251P180 | Metal film: 18 ohms \pm 5%, 1/10 w. |
| R29 | 19B800607P1 | Metal film: Jumper. |
| R30 | 19B801251P103 | Metal film: 10K ohms \pm 5%, 1/10 w. |
| R31 | 19B801251P562 | Metal film: 5.6K ohms \pm 5%, 1/10 w. |
| R32 | 19B801251P470 | Metal film: 47 ohms \pm 5%, 1/10 w. |
| R33 | 19B801251P750 | Metal film: 75 ohms \pm 5%, 1/10 w. |
| R34 and R35 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R36 thru R38 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. |
| R39 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R40 | 19B801251P390 | Metal film: 39 ohms ±5%, 1/10 w. |
| R41 | 19B801251P100 | Metal film: 10 ohms ±5%, 1/10 w. |
| R42 | 19B801251P333 | Metal film: 33K ohms ±5%, 1/10 w. |
| R43 | 19B801251P562 | Metal film: 5.6K ohms \pm 5%, 1/10 w. |
| R44 | 19B801251P223 | Metal film: 22K ohms \pm 5%, 1/10 w. |
| R45 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. |
| R46 | 19B801251P100 | Metal film: 10 ohms \pm 5%, 1/10 w. |
| R47 | 19B801251P333 | Metal film: 33K ohms ±5%, 1/10 w. |
| R48 | 19B801251P682 | Metal film: 6.8K ohms \pm 5%, 1/10 w. |
| R50 | 19B801251P390 | Metal film: 39 ohms \pm 5%, 1/10 w. |
| R52 | 19B801251P152 | Metal film: 1.5K ohms \pm 5%, 1/10 w. |
| R53 | 19B801251P750 | Metal film: 75 ohms \pm 5%, 1/10 w. |
| R100 | 19B801251P102 | Metal film: 1K ohms ±5%, 1/10 w. |
| R101 | 19B800607P1 | Metal film: Jumper. |
| R102 | 19B801251P472 | Metal film: 4.7K ohms \pm 5%, 1/10 w. |
| R105 | 19B800607P1 | Metal film: Jumper. |
| R106 and R107 | 19B801251P101 | Metal film: 100K ohms±5%, 1/10 w. |
| R201 | 19B801251P104 | Metal film: 100K ohms \pm 5%, 1/10 w. |
| R202 | 19B801251P153 | Metal film: 15K ohms \pm 5%, 1/10 w. |
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